



Material Content Data Sheet



Sales Product Name		AIHD15N60RF		Issued		24. January 2018		
MA#		MA001393178						
Package		PG-TO252-3-313		Weight*		318.01 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.995	0.63	0.63	6272	6272
leadframe	non noble metal	iron	7439-89-6	0.147	0.05		463	
	inorganic material	phosphorus	7723-14-0	0.044	0.01		139	
	non noble metal	copper	7440-50-8	147.096	46.25	46.31	462556	463158
wire	non noble metal	aluminium	7429-90-5	1.015	0.32	0.32	3192	3192
encapsulation	organic material	carbon black	1333-86-4	1.412	0.44		4441	
	plastics	epoxy resin	-	24.714	7.77		77716	
	inorganic material	silicondioxide	60676-86-0	115.098	36.19	44.40	361936	444093
leadfinish	non noble metal	tin	7440-31-5	3.740	1.18	1.18	11761	11761
plating	inorganic material	phosphorus	7723-14-0	0.003	0.00		11	
	non noble metal	nickel	7440-02-0	1.421	0.45	0.45	4467	4478
solder	noble metal	silver	7440-22-4	0.053	0.02		167	
	non noble metal	tin	7440-31-5	0.042	0.01		133	
	non noble metal	lead	7439-92-1	2.024	0.64	0.67	6363	6663
heatspreader	non noble metal	iron	7439-89-6	0.019	0.01		60	
	inorganic material	phosphorus	7723-14-0	0.006	0.00		18	
	non noble metal	copper	7440-50-8	19.177	6.03	6.04	60305	60383
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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